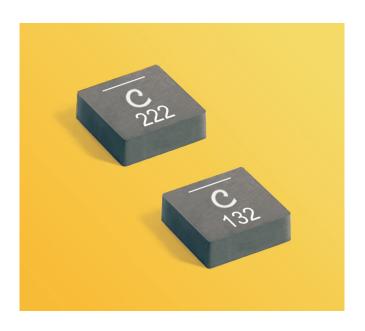
Power Inductors for Critical Applications ST591PYA



- High current and very low DCR
- Soft saturation makes them ideal for VRM/VRD applications

Core material Composite

Environmental RoHS compliant, halogen free

Terminations Tin-silver (96.5/3.5) over copper

Weight 4.5 - 4.9 g

Ambient temperature -40°C to +125°C with (40°C rise) Irms current.

Maximum part temperature +165°C (ambient + temp rise). Derating.

Storage temperature Component: -55°C to +165°C.

Tape and reel packaging: -40°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at $<30^{\circ}$ C / 85% relative humidity)

Packaging 400/13" reel Plastic tape: 24 mm wide, 0.3 mm thick, 20 mm pocket spacing, 5.2 mm pocket depth

PCB washing Tested to MIL-STD-202 Method 215 plus an additional aqueous wash. See Doc787_PCB_Washing.pdf.

			DCR		SRF		Irms (A)6	
Part number ¹	Inductance ² (µH)	Percent tolerance	(mO	hms)³ max	typ ⁴ (MHz)	Isat⁵ (A)	20°C rise	40°C rise
Fartifullibei	(μιι)	tolerance	typ	IIIax	(1411 12)	(^)	1136	1130
ST591PYA631_LZ	0.63	30, 20	1.50	1.70	50	74	21.0	28.5
ST591PYA931_LZ	0.93	30, 20	2.00	2.20	42	60	18.7	24.7
ST591PYA132_LZ	1.3	30, 20	2.50	2.70	33	56	17.2	24.0
ST591PYA222_LZ	2.2	30, 20	4.16	4.80	23	46	14.2	18.0
ST591PYA302_LZ	3.0	30, 20	5.86	6.80	19	37	12.0	15.7

1. When ordering, please specify tolerance and screening codes:

ST591PYA302NLZ

Tolerance: N = 30%, M = 20%

Screening: Z = Unscreened

Y = Unscreened (SLDC Option A)
W = Unscreened (SLDC Option B)
H = Coilcraft CP-SA-10001 Group A

G = Coilcraft CP-SA-10001 Group A (SLDC Option A) **D** = Coilcraft CP-SA-10001 Group A (SLDC Option B)

- Screening performed to the document's latest revision.
- Custom testing also available.
- 2. Inductance tested at 100 kHz, 0.1 Vrms, 0 Adc.
- 3. DCR measured on a micro-ohmmeter.
- 4. SRF measured using an Agilent/HP 4395A or equivalent.
- 5. DC current at which the inductance drops 30% (typ) from its value without current.
- 6. Current that causes the specified temperature rise from 25°C ambient.
- 7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

Irms Testing

Irms testing was performed on a 0.060" thick pcb with 4 oz. copper traces optimized to minimize additional temperature rise.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

ST591PYA Power Inductor

L vs Current L vs Frequency 0.8 Inductance (µH) 0.63 µH 0.4 3.0 µH Inductance (µH) 1.3 µH 20 60 Current (A) 0.93 µH 0.63 µH Inductance (µH) 0.6 0.4 0.1 0.2 0.1 100 50 Frequency (MHz) Current (A) Inductance (µH) 0.512 ±0.008 13,0 ±0,2 0.8 0.551 ±0.008 14,0 ±0,2 0 40 Current (A) 3.2 Indicates direction of terminals and start (short) lead. Connect high dv/dt here for lowest EMI. Dash number Inductance (µH) 2.2 µH $\frac{0.197}{5,0}$ max 0.8 0.110 ±0.004 $\frac{0.441}{11,2}$ typ 0 2,80 ±0,1 30 0.228 ±0.010 Current (A) 5.8 ±0.25 Inductance (µH) 0.339 8,6 3.0 µH 2.0 0.472 12.0 0 10 15 30 Current (A) 0.117 Suggested Dimensions are in $\frac{\text{inches}}{\text{mm}}$



www.coilcraft-cps.com

Land Pattern